

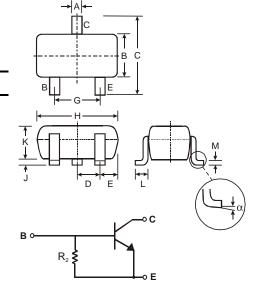
Features

- Epitaxial Planar Die Construction
- Complementary PNP Types Available (DDTA)
- Built-In Biasing Resistor, R2 only
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 and 4)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Marking: Date Code and Type Code, See Page 3
- Ordering Information: See Page 3
- Type Code: See Table Below
- Weight: 0.006 grams (approximate)

P/N	R2 (NOM)	Type Code
DDTC114GUA	10ΚΩ	N26
DDTC124GUA	22Κ Ω	N27
DDTC144GUA	47ΚΩ	N28
DDTC115GUA	100KΩ	N29



SCHEMATIC	DIACRAM
COLICIVIZATIO	DIACINAIN

SOT-323									
Dim	Min	Max							
Α	0.25	0.40							
В	1.15	1.35							
С	2.00 2.20								
D	0.65 Nominal								
Е	0.30 0.40								
G	1.20	1.40							
Н	1.80	2.20							
J	0.0 0.10								
K	0.90	1.00							
L	0.25	0.40							
М	0.10	0.18							
α	0°	8°							
All Dimensions in mm									

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Collector-Base Voltage	V _{CBO}	50	V	
Collector-Emitter Voltage	V _{CEO}	50	V	
Emitter-Base Voltage	V _{EBO}	5	V	
Collector Current	I _C (Max)	100	mA	
Power Dissipation	P _d	200	mW	
Thermal Resistance, Junction to Ambient Air (Note 1)	$R_{ heta JA}$	625	°C/W	
Operating and Storage Temperature Range	T _j , T _{STG}	-55 to +150	°C	

Notes:

- 1. Mounted on FR4 PC Board with recommended pad layout as shown on Diodes Inc., suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. No purposefully added lead.
- 3. Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- Product manufactured with date code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product
 manufactured prior to date code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

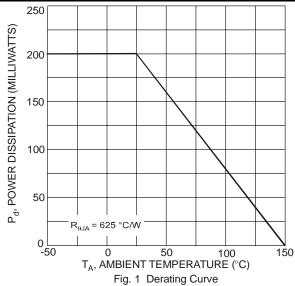


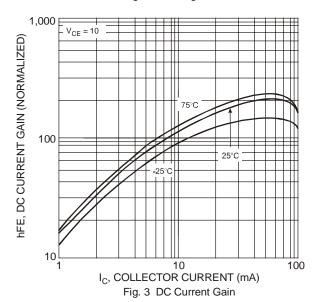
Electrical Characteristics @T_A = 25°C unless otherwise specified

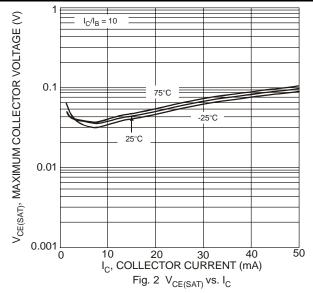
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
Collector-Base Breakdown Voltage		BV _{CBO}	50	_		V	$I_C = 50\mu A$
Collector-Emitter Breakdown Voltage)	BV _{CEO}	50	_		V	$I_C = 1mA$
Emitter-Base Breakdown Voltage		BV _{EBO}	5		_	V	I_E = 720 μ A, DDTC114GUA I_E = 330 μ A, DDTC124GUA I_E = 160 μ A, DDTC144GUA I_E = 72 μ A, DDTC115GUA
Collector Cutoff Current		I _{CBO}			0.5	μΑ	$V_{CB} = 50V$
Emitter Cutoff Current	DDTC114GUA DDTC124GUA DDTC144GUA DDTC115GUA	I _{EBO}	300 140 65 30	_	580 260 130 58	μА	V _{EB} = 4V
Collector-Emitter Saturation Voltage		V _{CE(sat)}			0.3	V	$I_C = 10 \text{mA}, I_B = 0.5 \text{mA}$
DDTC114GUA DC Current Transfer Ratio DDTC124GUA DDTC124GUA DDTC144GUA DDTC115GUA		h _{FE}	30 56 68 82		_	_	I _C = 5mA, V _{CE} = 5V
Bleeder Resistor (R ₂) Tolerance		ΔR_2	-30	_	+30	%	_
Gain-Bandwidth Product*		f⊤	_	250	_	MHz	$V_{CE} = 10V, I_{E} = -5mA,$ f = 100MHz

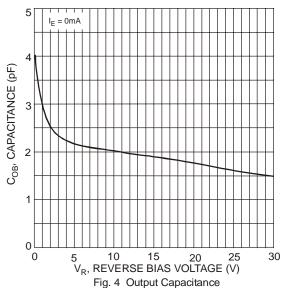
^{*} Transistor - For Reference Only

Typical Characteristics - DDTC114GUA

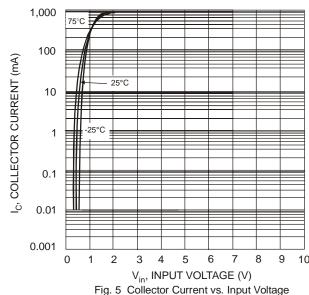


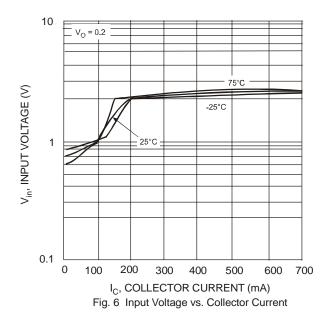










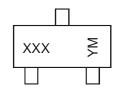


Ordering Information (Note 4 & 5)

Device	Packaging	Shipping
DDTC114GUA-7-F	SOT-323	3000/Tape & Reel
DDTC124GUA-7-F	SOT-323	3000/Tape & Reel
DDTC144GUA-7-F	SOT-323	3000/Tape & Reel
DDTC115GUA-7-F	SOT-323	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



XXX = Product Type Marking Code, See Table on Page 1

YM = Date Code Marking Y = Year ex: T = 2006 M = Month ex: 9 = September

Date Code Key

Year	200	6	2007		2008	20	09	2010		2011	2	2012
Code	Т		U		V	V	٧	Х		Υ		Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D

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